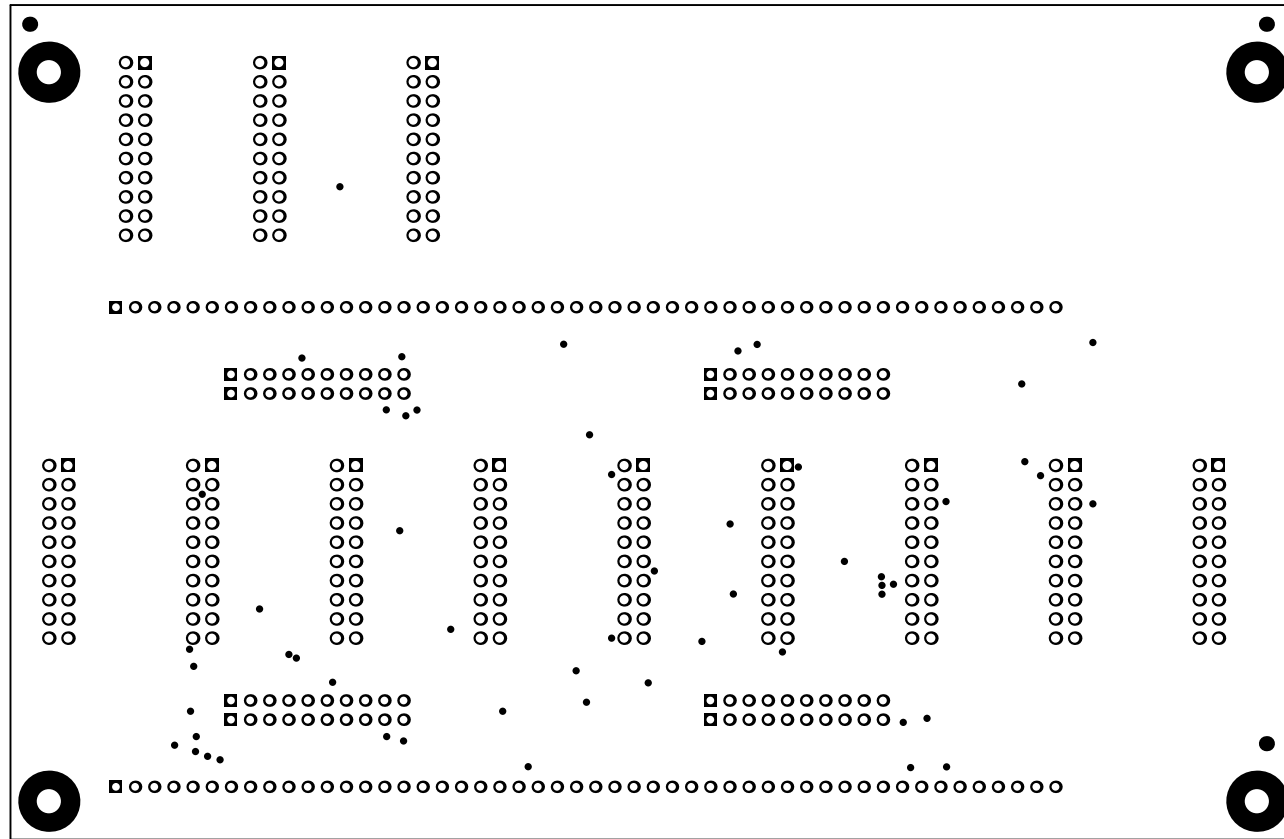
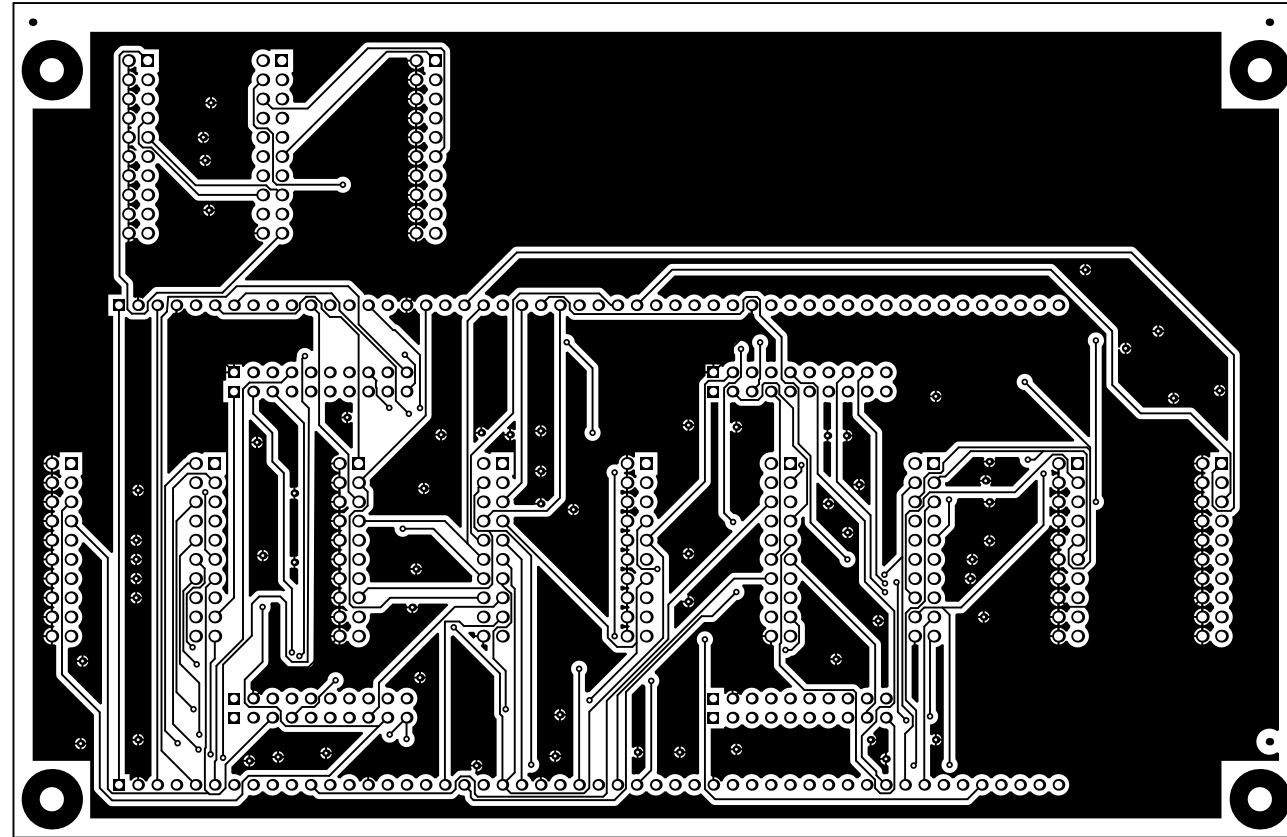


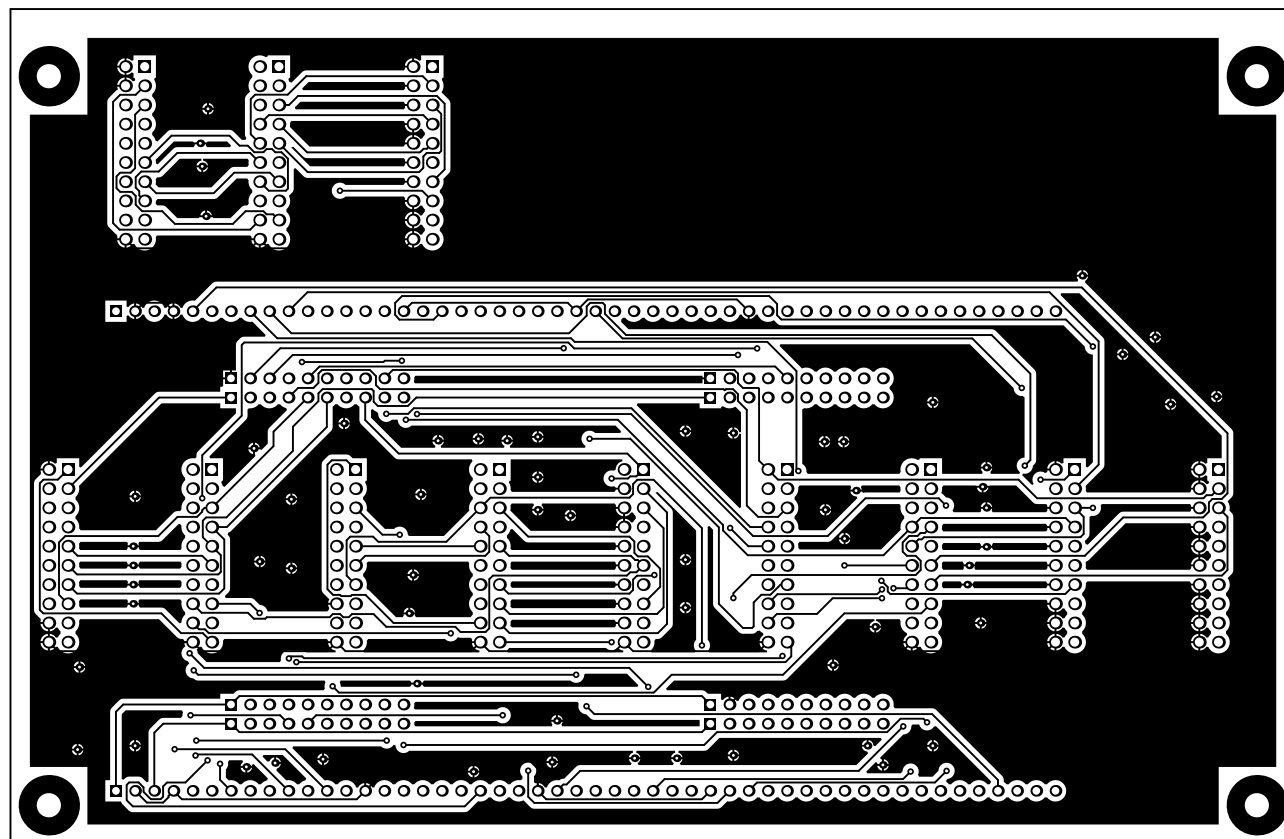
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDM-HAHSCTO	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay	TID #: TIDM-HAHSCTO		
PLOT NAME = Top Overlay	GENERATED : 5/17/2016	3:18:41 PM	TEXAS INSTRUMENTS



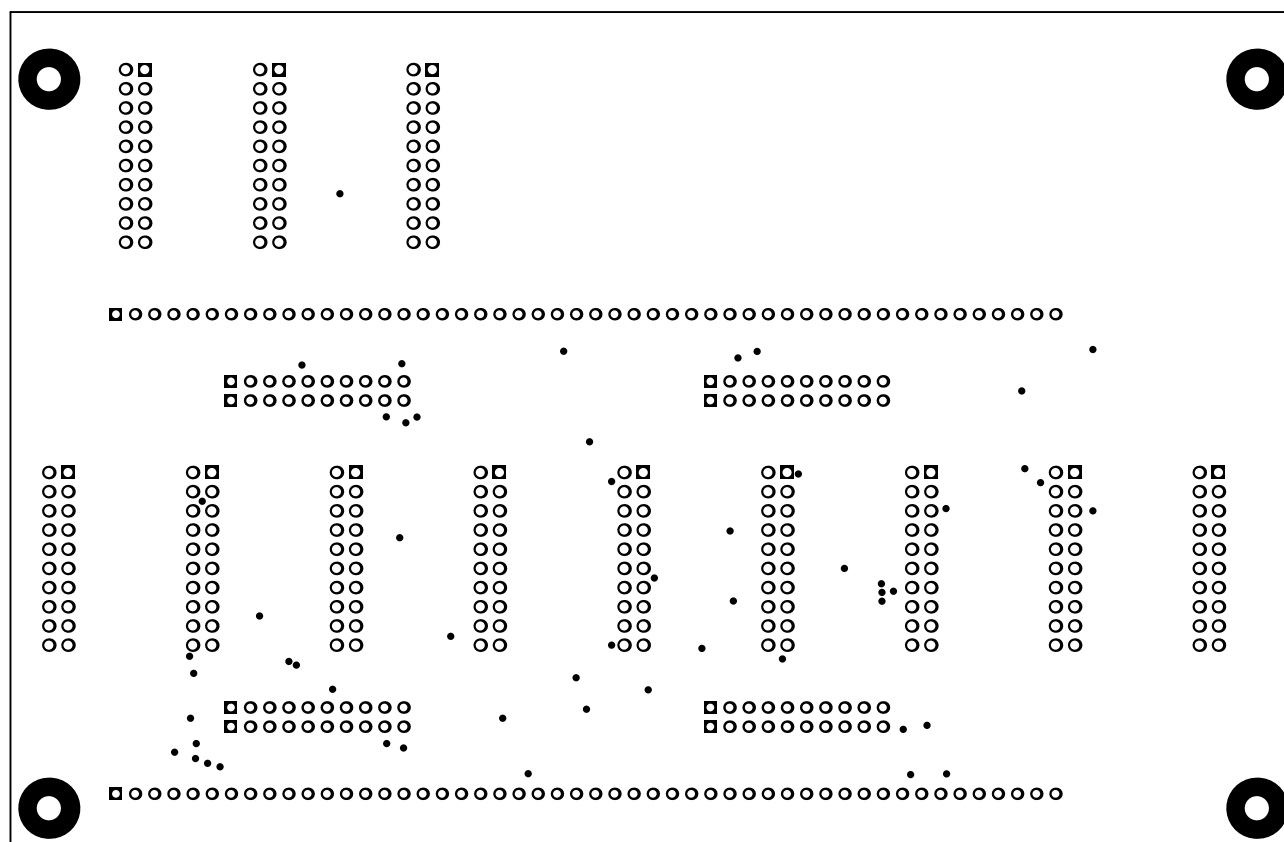
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDM-HAHSCTO	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Top Solder	TID #: TIDM-HAHSCTO		
PLOT NAME = Top Solder Mask	GENERATED : 5/17/2016	3:18:42 PM	TEXAS INSTRUMENTS



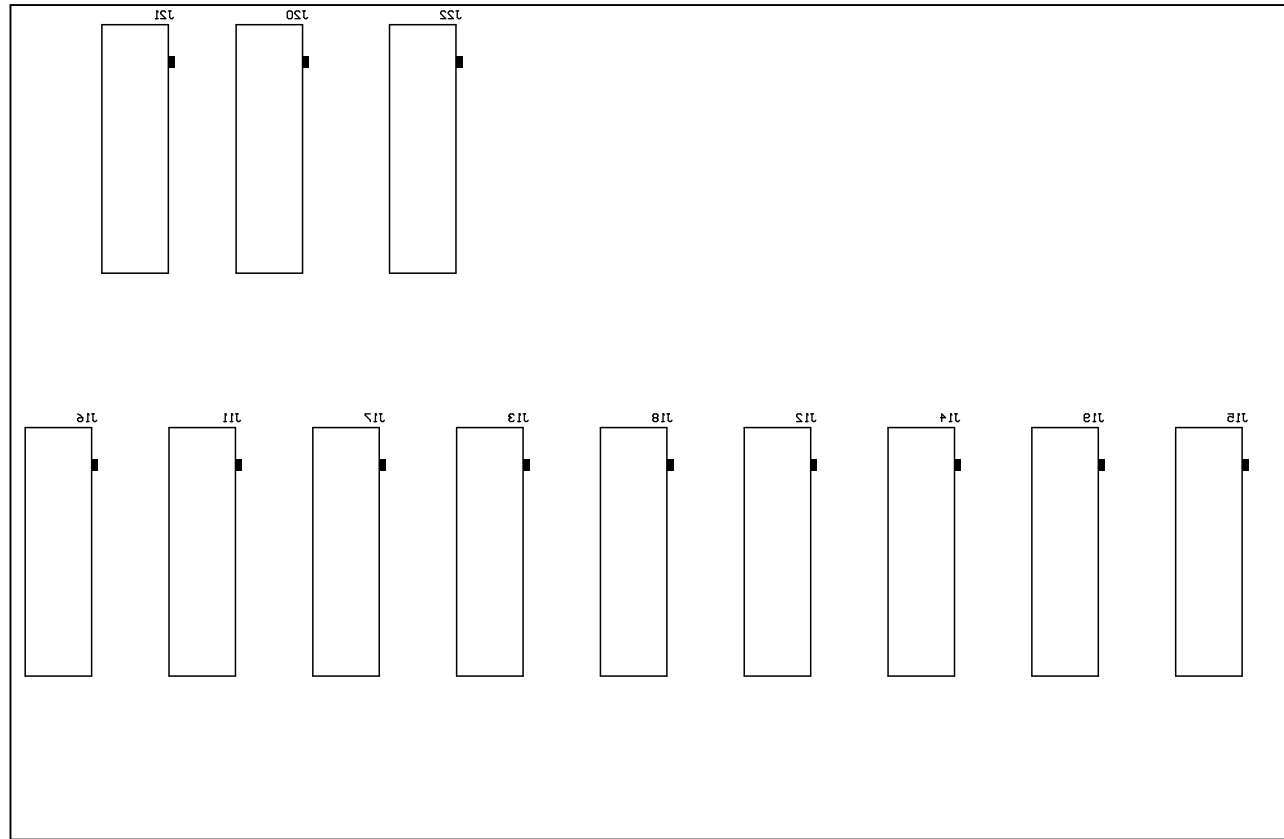
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDM-HAHSCTO REV: A	SUN REV: Not In VersionControl
LAYER NAME = Top Layer	TID #: TIDM-HAHSCTO	
PLOT NAME = Top Layer	GENERATED : 5/17/2016 3:18:43 PM	TEXAS INSTRUMENTS



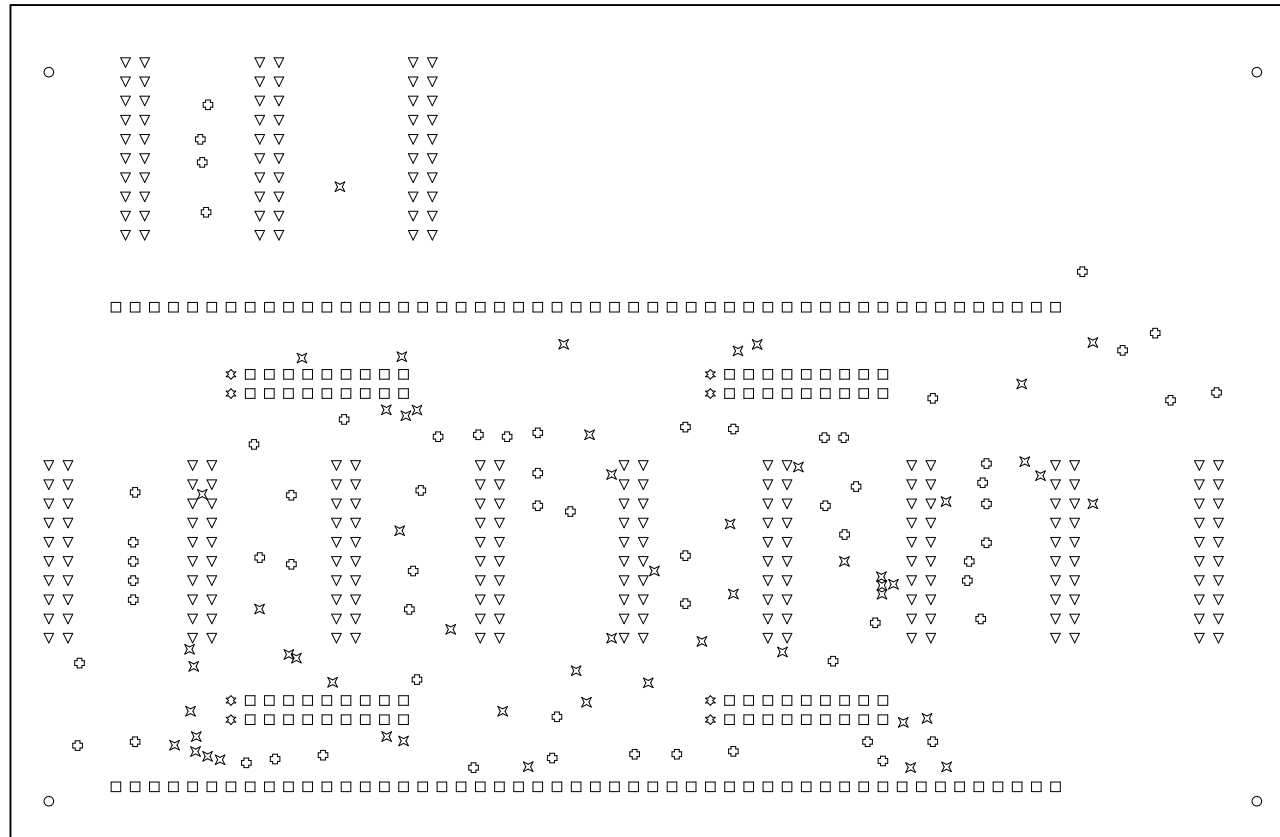
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDM-HAHSCTO REV: A	SUN REV: Not In VersionControl
LAYER NAME = Bottom Layer	TID #: TIDM-HAHSCTO	
PLOT NAME = Bottom Layer	GENERATED : 5/17/2016 3:18:44 PM	TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDM-HAHSCTO	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder	TID #: TIDM-HAHSCTO		
PLOT NAME = Bottom Solder Mask	GENERATED : 5/17/2016	3:18:45 PM	TEXAS INSTRUMENTS

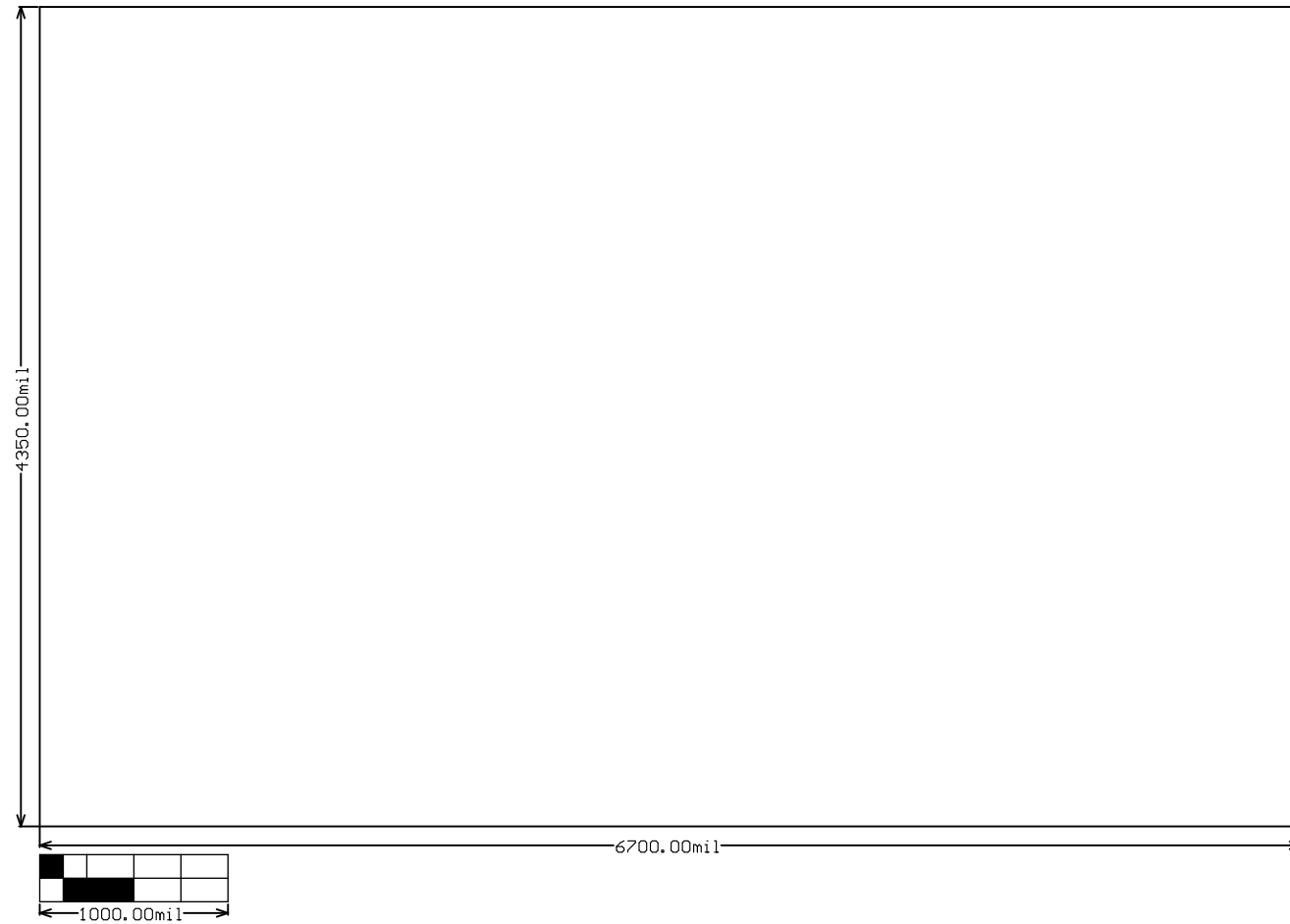


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDM-HAHSCTO	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Bottom Overlay	TID #: TIDM-HAHSCTO		
PLOT NAME = Bottom Overlay	GENERATED : 5/17/2016	3:18:45 PM	TEXAS INSTRUMENTS



Symbol	Quantity	Finished Hole Size	Plated	Hole Type	Drill Layer Pair	Hole Tolerance
⊗	64	15.00mil (0.381mm)	PTH	Round	Top Layer - Bottom Layer	
⊗	55	16.00mil (0.406mm)	PTH	Round	Top Layer - Bottom Layer	
⊗	8	40.00mil (1.016mm)	PTH	Round	Top Layer - Bottom Layer	
□	172	40.16mil (1.020mm)	PTH	Round	Top Layer - Bottom Layer	
▽	240	47.24mil (1.200mm)	PTH	Round	Top Layer - Bottom Layer	
○	4	125.98mil (3.200mm)	PTH	Round	Top Layer - Bottom Layer	
	<b>543 Total</b>					

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDM-HAHSCTO	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing	TID #: TIDM-HAHSCTO		
PLOT NAME = Drill Drawing	GENERATED : 5/17/2016	3:18:46 PM	TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDM- <del>HAHSCPT</del> 0	REV: A	SUN REV: Not In VersionControl
LAYER NAME = M2 Board Dimensions	TID #: TIDM- <del>HAHSCPT</del> 0		
PLOT NAME = Board Dimensions	GENERATED : 5/17/2016	3:18:47 PM	TEXAS INSTRUMENTS



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